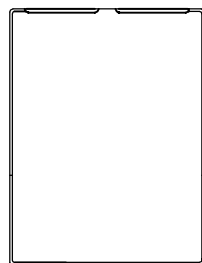
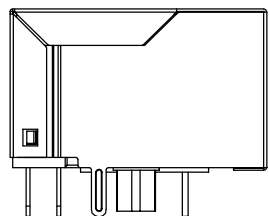


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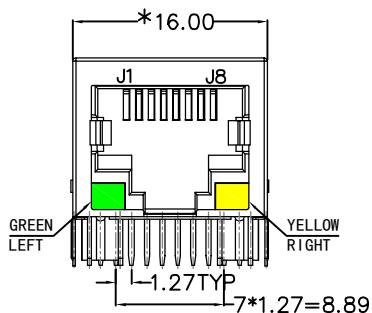
REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	MQ.Qu	2017.11.14



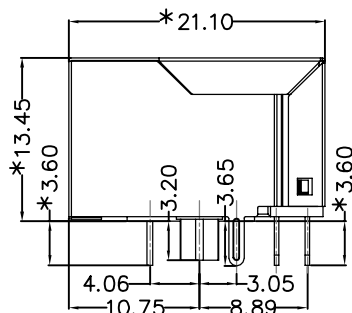
TOP VIEW



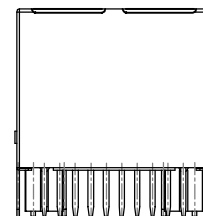
LEFT SIDE VIEW



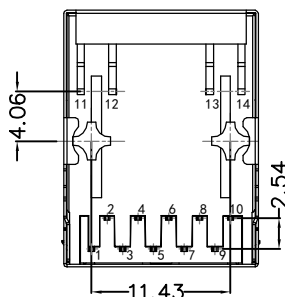
FRONT VIEW



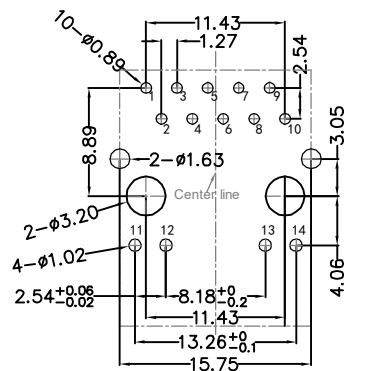
RIGHT SIDE VIEW



BACK VIEW



BOTTOM VIEW



RECOMMENDED PCB LAYOUT
VIEWED FROM COMPONENT SIDE

MATERIAL:

HOUSING: PBT,UL94V-0,BLACK.
TERMINALS BRACKET: PBT,UL94V-0,BLACK.
SHIELD: C2680,T=0.20MM,NICKEL PLATING ON ALL AREA.
TERMINAL: PHOSPHOR BRONZE C5210,T=0.35MM,
6U" GOLD PLATING ON CONTACT AREA.

MECHANICAL:

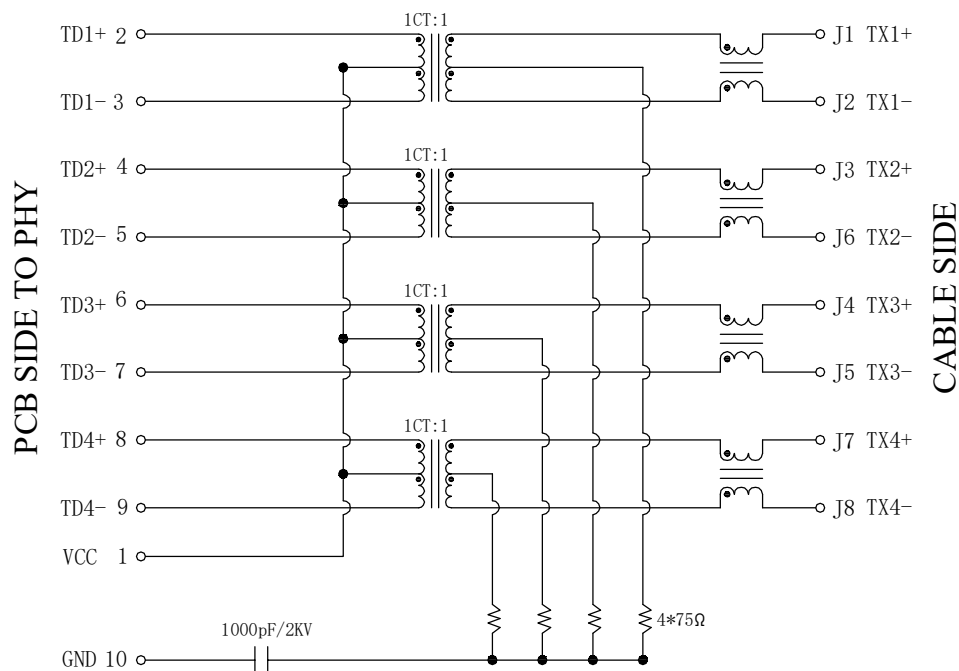
DURABILITY: 750 CYCLES MIN.
MATING FORCE: 23N MAX.
OPERATING TEMPERATURE: -40°C~+85°C.
STORAGE TEMPERATURE: -40°C~+85°C.
ALL CRITICAL DIMENSIONS WITH "*"



TITLE: TAB-DOWN 1X1 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: SYT111Q106AB2A1D	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: TW.Xu
REMARK:	SHEET 1/3		.xx±0.25	.xx°±1.5°	DESIGND BY: MQ.Qu
			.xxx±0.10	.xxx°±1.0°	

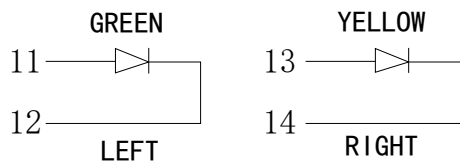
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REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	MQ.Qu	2017.11.14



Electrical:

- Turn ratio: 2~3: J1~J2=1CT:1CT(±2%).
4~5: J3~J6=1CT:1CT(±2%).
6~7: J4~J5=1CT:1CT(±2%).
8~9: J7~J8=1CT:1CT(±2%).
- OCL: 350uH Min. at 100KHz 100mV 8mA DC.
- Insertion Loss: -1.0 dB Max 1~100MHz.
- Return loss: -18dB Min 1~30MHz;
-14dB Min 30~60MHz.
-12dB Min 60~80MHz.
-10dB Min 80~100MHz.
- Cross talk: -40dB Min 1~30MHz;
-35dB Min 30~60MHz;
-30dB Min 60~100MHz;
- CMR: -30dB Min 1~100MHz;
- Hi-Pot: 1500V AC & 2250V DC
6S 1mA PRI TO SEC



LED Specification

Standard LED Color	LED Wavelength	Foward(A)	Foward(V)
Green	568nm	20mA	1.85-2.45V
Yellow	585nm	20mA	1.7-2.2V

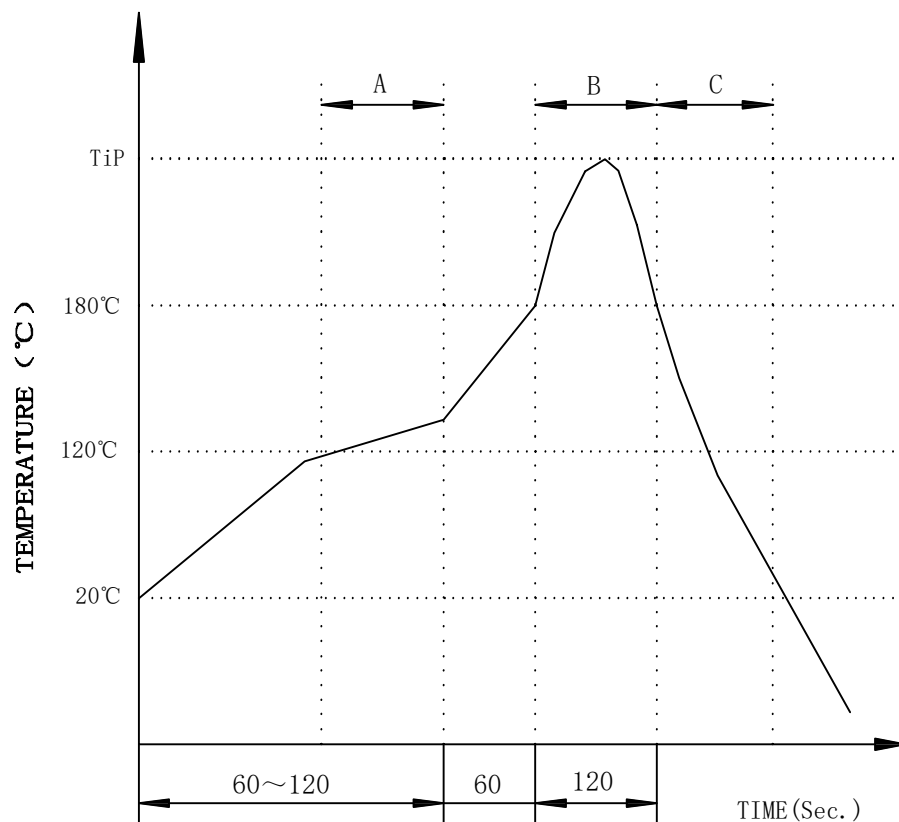


TITLE: TAB-DOWN 1X1 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: SYTF111Q106AB2A1D	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: TW.Xu
REMARK:	SHEET 2/3		.xx±0.25	.xx°±1.5°	DESIGND BY: MQ.Qu
			.xxx±0.10	.xxx°±1.0°	

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PROFILE OF WAVE SOLDER

REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	MQ.Qu	2017.11.14



A.Preheating B.Soldering C.Gradual Cooling
 Tip temperature:260±5°C.
 Tip temperature time:5Sec Max.
 Tip melting point of Sn96.5/Ag3/Cu0.5:217°C.

Remarks: after wave soldering, the plastic positioning columns
 of the product which under the PCB will be slightly melted,
 but it won't affect its function.

WOHU 苏州沃虎电子科技有限公司
 Su Zhou Wo Hu Electronic Tech.Co.,Ltd.

TITLE: TAB-DOWN 1X1 1000BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: SYT111Q106AB2A1D	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: TW.Xu
REMARK:	SHEET 3/3		.xx±0.25	.xx°±1.5°	DESIGND BY: MQ.Qu
			.xxx±0.10	.xxx°±1.0°	